

先进负载管理开关

FPF1504 / FPF1504L

说明

FPF1504/FPF1504L是IntelliMAX™系列的低RDS P沟道MOSFET负载开关。集成的压摆率控制可防止过量浪涌电流干扰电源应用中通用的电容负载的电源电压轨。此外, FPF1504/FPF1504L具有输出放电功能。

输入电压的工作范围为1.0 V到3.6 V, 可满足当今移动设备的供电要求。开关控制是通过能够直接连接嵌入式处理器中的低压CMOS控制信号和GPIO的逻辑输入(ON引脚)来实现的。

特性

- 1.0至3.6 V的输入电压工作范围
- 典型RDS(ON):
 - ◆ $15 \text{ m}\Omega$ ($V_{IN} = 3.3 \text{ V}$ 时)
 - ◆ $20 \text{ m}\Omega$ ($V_{IN} = 1.8 \text{ V}$ 时)
 - ◆ $V_{IN} = 1.0 \text{ V}$ 时为 $40 \text{ m}\Omega$
- 转换速率控制
- 输出放电功能
- 小于 $1 \mu\text{A}$ 的低静态电流($V_{ON} = V_{IN}$)
- 静电放电保护: 4000 V HBM, 2000 V CDM
- 兼容GPIO/CMOS的使能电路
- 高电平有效版本和低电平有效版本

应用

- 移动设备和智能手机
- 便携式媒体设备
- 数码相机
- 高级笔记本电脑、超便携移动个人电脑和移动互联网设备
- 便携式医疗设备
- 全球定位系统和导航设备

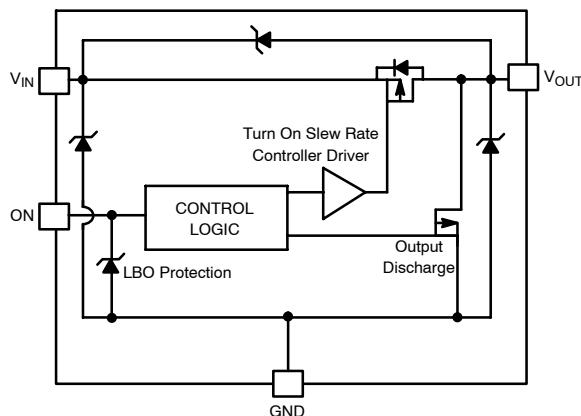
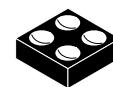
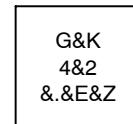


图 1. 框图



WLCSP4
CASE 567RH

MARKING DIAGRAM



G	= 1 st Digit of 2 Digit Device ID Mark
&K	= 2-Digits Lot Run Traceability Code
4	= 2 nd Digit of 2 Digit Device ID Mark
&2	= 2-digit Date Code Format
&.	= Pin 1 Identifier
&E	= Space Designator
&Z	= Assembly Plant Code

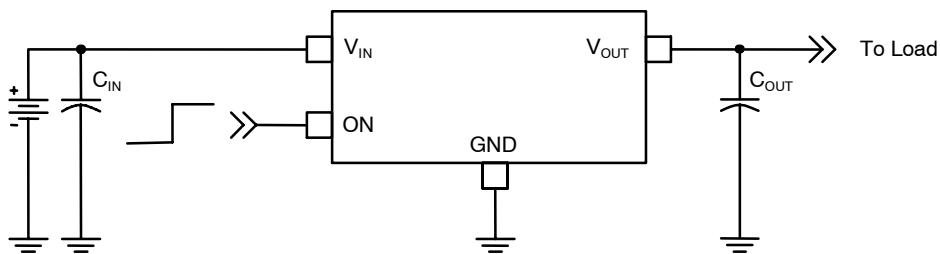
订购信息

请参阅本数据表第 2 页封装尺寸部分的详细订购和装运信息。

订购信息

器件型号	顶标	1.8 V _{IN}	输入缓冲	输出放电	ON引脚动作	封装
		的开关(典型值)				
FPF1504UCX	G4	20 mΩ	CMOS	是	高电平有效	4引脚, WLCSP, 0.5 mm引脚间距
FPF1504BUCX	G4	20 mΩ	CMOS	是	高电平有效	4引脚, WLCSP封装, 背部层压, 0.5 mm引脚间距
FPF1504LUCX	GZ	20 mΩ	CMOS	是	低电平有效	4引脚, WLCSP, 0.5 mm引脚间距
FPF1504LBUCX	G4	20 mΩ	CMOS	是	低电平有效	4引脚, WLCSP封装, 背部层压, 0.5 mm引脚间距

应用框图



说明: 1. C_{IN} = 1 mF, X5R, 0603, 例如 Murata GRM185R60J105KE26.
2. C_{OUT} = 1 mF, X5R, 0805, 例如 Murata GRM216R61A105KA01.

图 2. 典型应用

引脚布局

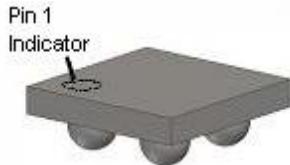


图 3. 1 x 1 毫米 WLCSP 封装, 凸块向下

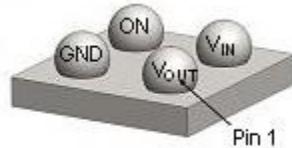


图 4. 1 x 1 毫米 WLCSP 封装, 凸块向上

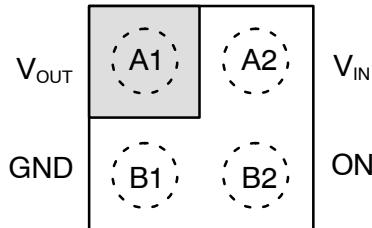


图 5. 引脚分配(顶视图/俯视图)

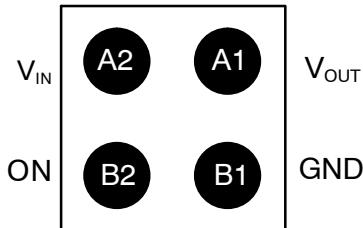


图 6. 引脚布局(底视图)

引脚说明

引脚号	名称	说明
A1	V _{OUT}	开关输出
A2	V _{IN}	电源输入；电源开关的输入
B1	GND	接地
B2	ON	导通/关断控制

绝对最大额定

符号	参数	最小值	最大值	单位
V _{IN}	V _{IN} , V _{OUT} , V _{ON} 到 GND	-0.3	4.0	V
I _{SW}	连续开关电流最大值		1.1V	A
P _D	功耗(T _A = 25°C)		1.0	W
T _{STG}	存储结温	-65	150	°C
T _A	工作温度范围	-40	85	°C
θ_{JA}	结至环境热阻 1S2P, 1 热阻通过 1S2P, 无热阻通过	95 187		
				°C/W
ESD	静电放电能力 人体模型, JESD22-A114 充电器件模式, JESD22-C101	4		kV
		2		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

(参考译文)

如果电压超过最大额定值表中列出的值范围，器件可能会损坏。如果超过任何这些限值，将无法保证器件功能，可能会导致器件损坏，影响可靠性。

推荐工作条件

符号	参数	最小值	最大值	单位
V _{IN}	电源电压	1.0	3.6V	V
T _A	工作环境温度	-40	85	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

(参考译文)

高于推荐工作范围表格中所列电压时，不保证能够正常运行。长时间在推荐工作范围表格中规定范围以外的电压下运行，可能会影响器件的可靠性。

FPF1504 / FPF1504L

电气特性

除非另有说明, $V_{IN} = 1.0$ 至 3.6 V , $T_A = -40$ 至 $+85^\circ\text{C}$, $V_{IN} = 3.3\text{ V}$, $T_A = 25^\circ\text{C}$ 时为典型值。

符号	参数		工作条件	最小值	典型值	最大值	单位
基本工作							
V_{IN}	电源电压			1.0		3.7	V
$I_Q(OFF)$	关断电源电流	FPF1504	$V_{ON} = \text{接地}$, $V_{OUT} = \text{开路}$		0.25		μA
		FPF1504L	$V_{ON} = V_{IN}$, $V_{OUT} = \text{开路}$		0.3		
$I_{SD(OFF)}$	关断开关电流	FPF1504	$V_{ON} = \text{GND}$, $V_{OUT} = \text{GND}$		0.25		
		FPF1504L	$V_{ON} = V_{IN}$, $V_{OUT} = \text{GND}$		0.3		
I_Q	静态电流	FPF1504	$I_{OUT} = 0\text{ mA}$, $V_{IN} = 3.6\text{ V}$, $V_{ON} = V_{IN}$		0.08		
			$I_{OUT} = 0\text{ mA}$, $V_{ON} = V_{IH(\text{MIN})}$		0.75		
		FPF1504L	$I_{OUT} = 0\text{ mA}$, $V_{IN} = 3.6\text{ V}$, $V_{ON} = \text{GND}$		0.08		
			$I_{OUT} = 0\text{ mA}$, $V_{ON} = V_{IL(\text{MAX})}$		0.95		
R_{ON}	导通电阻		$V_{IN} = 3.3\text{ V}$, $I_{OUT} = 200\text{ mA}$, $T_A = 25^\circ\text{C}$		15	30	$\text{m}\Omega$
			$V_{IN} = 1.8\text{ V}$, $I_{OUT} = 200\text{ mA}$, $T_A = 25^\circ\text{C}$		20	40	
			$V_{IN} = 1.25\text{ V}$, $I_{OUT} = 200\text{ mA}$, $T_A = 25^\circ\text{C}$		30		
			$V_{IN} = 1.0\text{ V}$, $I_{OUT} = 200\text{ mA}$, $T_A = 25^\circ\text{C}$		40	80	
			$V_{IN} = 1.8\text{ V}$, $I_{OUT} = 200\text{ mA}$, $T_A = 85^\circ\text{C}$ (Note 3)				
R_{PD}	输出放电下拉电阻		$V_{ON} = 0\text{ V}$ or V_{IN} , $I_{OUT} = -20\text{ mA}$		65	95	Ω
V_{IH}	导通输入逻辑高电压	FPF1504		0.8			V
V_{IL}	导通输入逻辑低电压	FPF1504				0.3	
I_{ON}	导通输入漏电流				1		μA

动态特性

t_{DON}	导通延迟 (4)	FPF1504	$R_L = 10\text{ }\Omega$, $C_L = 0.1\text{ }\mu\text{F}$, $V_{IN} = 3.3\text{ V}$, $T_A = 25^\circ\text{C}$		80		μs
t_R	V_{OUT} 上升时间 (Note 4)	FPF1504			130		
t_{ON}	导通时间 (Note 4)	FPF1504			210		
t_{DON}	导通延迟 (Note 4)	FPF1504	$R_L = 500\text{ }\Omega$, $C_L = 0.1\text{ }\mu\text{F}$, $V_{IN} = 3.3\text{ V}$, $T_A = 25^\circ\text{C}$		70	100	μs
		FPF1504L			95		
t_R	V_{OUT} 上升时间 (Note 4)	FPF1504			110	150	
		FPF1504L			115		
t_{ON}	导通时间 (Note 4)	FPF1504			180	250	
		FPF1504L			210		

FPF1504 / FPF1504L

电气特性 (continued)

除非另有说明, $V_{IN} = 1.0$ 至 3.6 V , $T_A = -40$ 至 $+85^\circ\text{C}$, $V_{IN} = 3.3\text{ V}$, $T_A = 25^\circ\text{C}$ 时为典型值。

符号	参数	工作条件	最小值	典型值	最大值	单位
动态特性						
t_{DOFF}	关断延迟 (Note 4)	FPF1504		25	30	μs
t_F	V_{OUT} 下降时间 (Note 4)	FPF1504		2		
t_{OFF}	关断时间 (Note 4)	FPF1504		27		
t_{DOFF}	关断延迟 (Note 4)	FPF1504		25		μs
		FPF1504L		2		
t_F	V_{OUT} 下降时间 (Note 4)	FPF1504		12		
		FPF1504L		14		
t_{OFF}	关断时间 (Note 4)	FPF1504		37		
		FPF1504L		16		

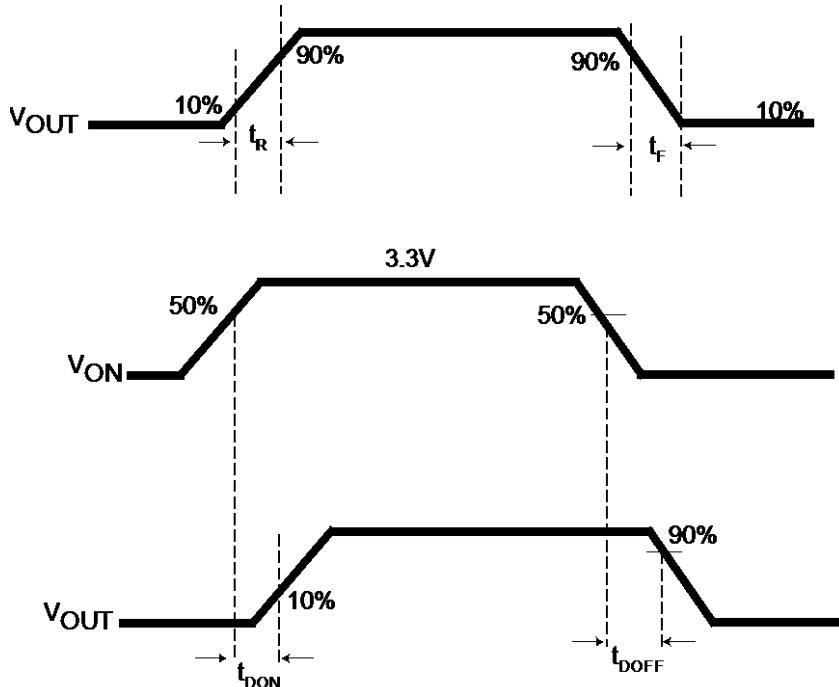
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

(参考译文)

除非另有说明，“电气特性”表格中列出的是所列测试条件下的产品性能参数。如果在不同条件下运行，产品性能可能与“电气特性”表格中所列性能参数不一致。

3. 该参数通过设计和特性得到保证，无需生产测试。
4. $t_{DON}/t_{DOFF}/t_R/t_F$ 在 中进行定义图7。
5. 断开时，输出放电路径开启。

时序图 – FPF1504



说明: 6. $t_{ON} = t_R + t_{DON}$.
7. $t_{OFF} = t_F + t_{DOFF}$.

图 7. FPF1504时序图

FPF1504的典型性能特征

仅适用于高电平有效版本。

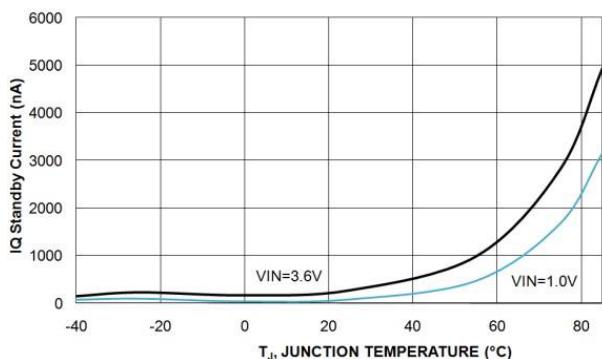


图 1. 关断电流与温度的关系

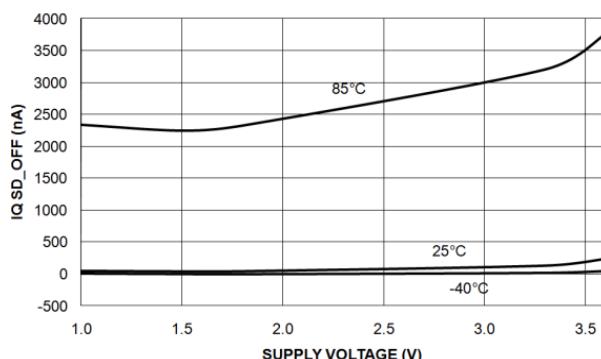


图 2. 关断电流与电源电压的关系

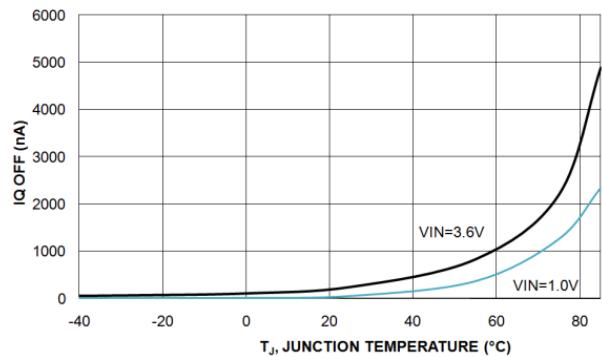


图 3. 关断电源电流与温度的关系

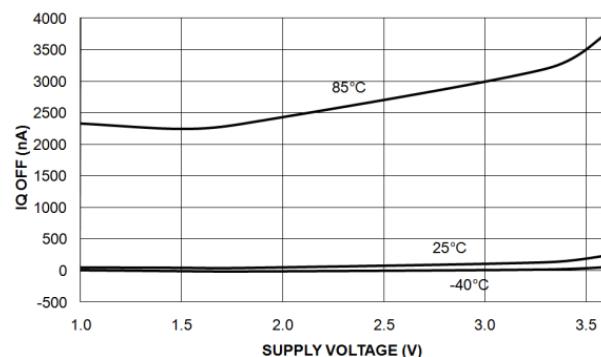


图 4. 关断电源电流与电源电压的关系

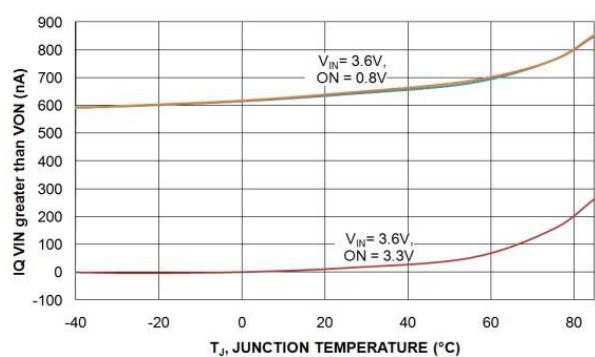


图 5. 关断电源电流与电源电压的关系

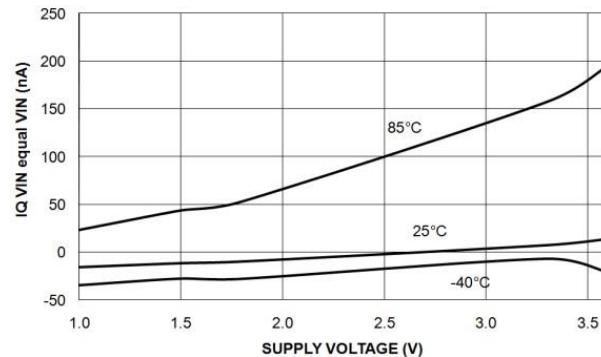


图 6. 静态电流与电源电压的关系
(V_{ON} = V_{IN})

FPF1504的典型性能特征

仅适用于高电平有效版本。

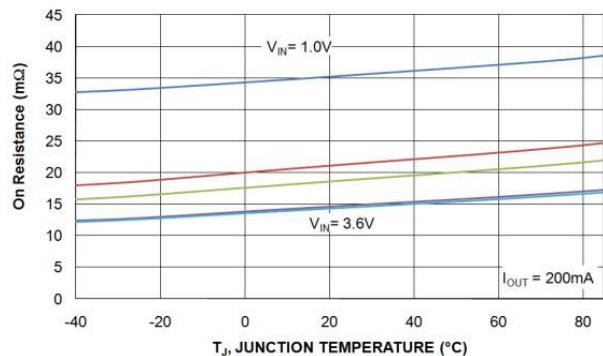


图 7. R_{ON} 与温度的关系

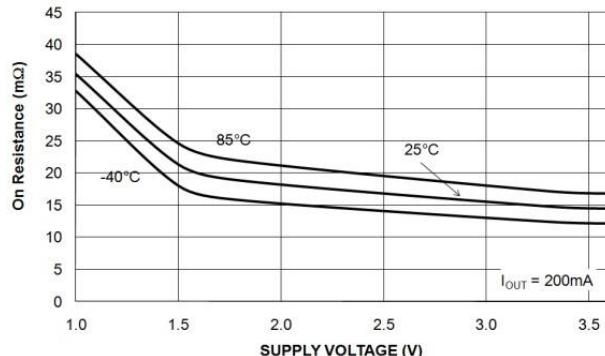


图 8. R_{ON} 与温度的关系

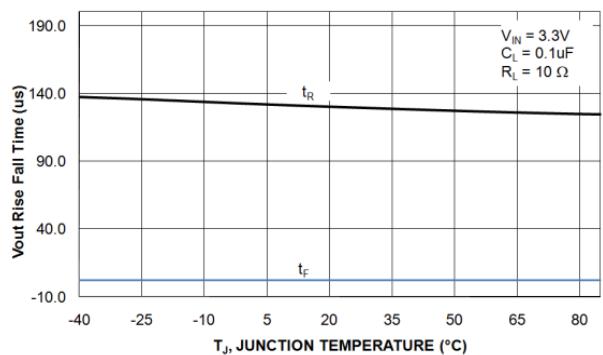


图 9. V_{OUT} 上升/下降时间与温度的关系
(R_L = 10 Ω)

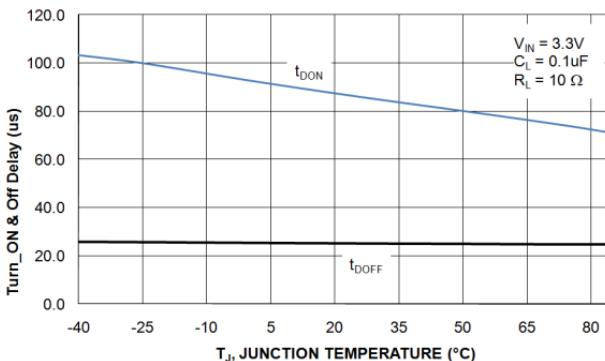


图 10. V_{OUT} 导通/关闭延迟与温度的关系
(R_L = 10 Ω)

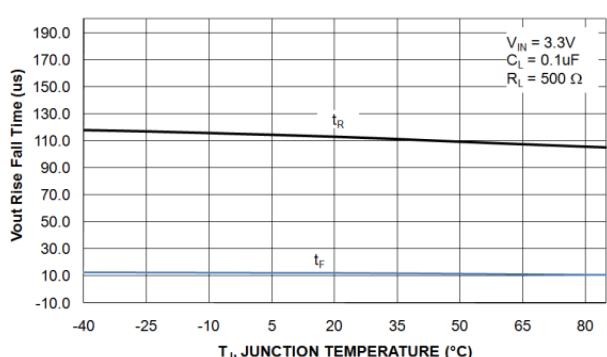


图 11. V_{OUT} 上升/下降时间与温度的关系
(R_L = 500 Ω)

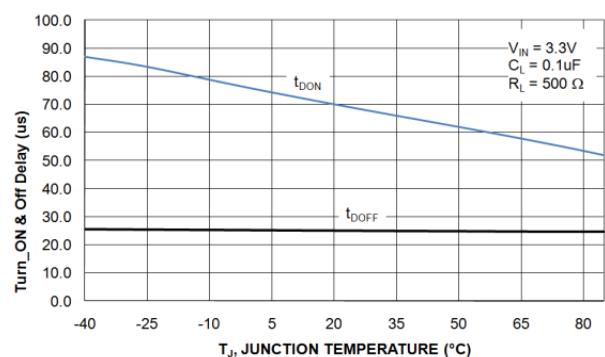


图 12. V_{OUT} 导通/关闭延迟与温度的关系
(R_L = 500 Ω)

FPF1504的典型性能特征

仅适用于高电平有效版本。

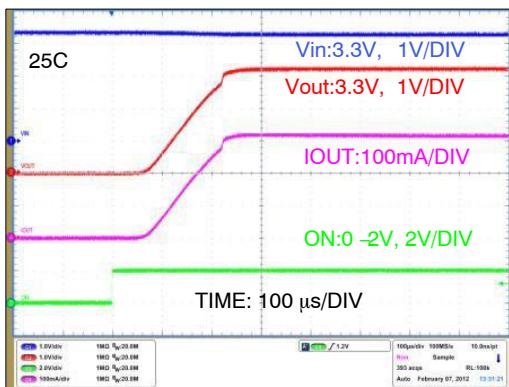


图 13. 导通响应
($V_{IN} = 3.3V$, $C_{OUT} = 0.1\mu F$, $R_L = 10\Omega$)

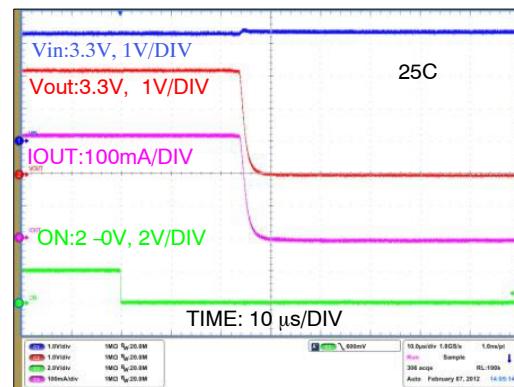


图 14. 关断响应
($V_{IN} = 3.3V$, $C_{OUT} = 0.1\mu F$, $R_L = 10\Omega$)

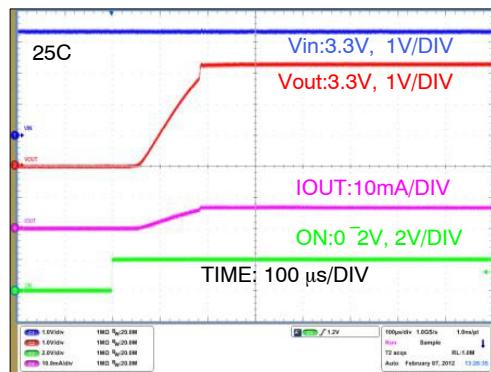


图 15. 导通响应
($V_{IN} = 3.3V$, $C_{OUT} = 0.1\mu F$, $R_L = 500\Omega$)

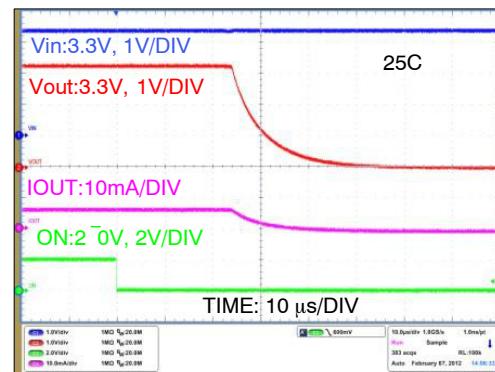


图 16. 关断响应
($V_{IN} = 3.3V$, $C_{OUT} = 0.1\mu F$, $R_L = 500\Omega$)

应用信息

输入电容

IntelliMAX开关无需输入电容。为了降低设备的浪涌电流，建议靠近 V_{IN} 引脚放置一个 $0.1 \mu\text{F}$ 的电容 C_{IN} 。使用更大的 C_{IN} 可进一步降低开关导通至更大的电容负载时造成的电压跌落。

输出电容

IntelliMAX开关无需输出电容亦可工作。如果断开时应用电路板寄生电感使得 V_{OUT} 低于 GND，必须在 V_{OUT} 和 GND 引脚之间放置一个 $0.1 \mu\text{F}$ 电容 C_{OUT} 。

下降时间

设备输出下降时间可以根据如下所示外部元件 RC 常数计算出来。

$$t_F = R_L \times C_L \times 2.2 \quad (\text{eq. 1})$$

其中，下降时间 t_F 为 90% 至 10%， R_L 为输出负载， C_L 为输出电容。

同一等式也适用于带下拉输出电阻的设备，则 R_L 由并联下拉电阻和外部输出电阻级联所替代，如下所示：

$$t_F = \frac{R_L \times R_{PD} \times C_L}{R_L + R_{PD}} \times 2.2 \quad (\text{eq. 2})$$

其中， t_F 为 90% 至 10% 的下降时间， R_L 为输出负载， R_{PD} 为输出下拉电阻(65Ω 典型值 L)， C_L 为输出电容。

建议焊盘模式和布局

为获得最佳热性能和最低电感与寄生影响，建议输入、输出线路短路，电容尽可能靠近设备。以下建议布局，可使设备实现最佳性能。

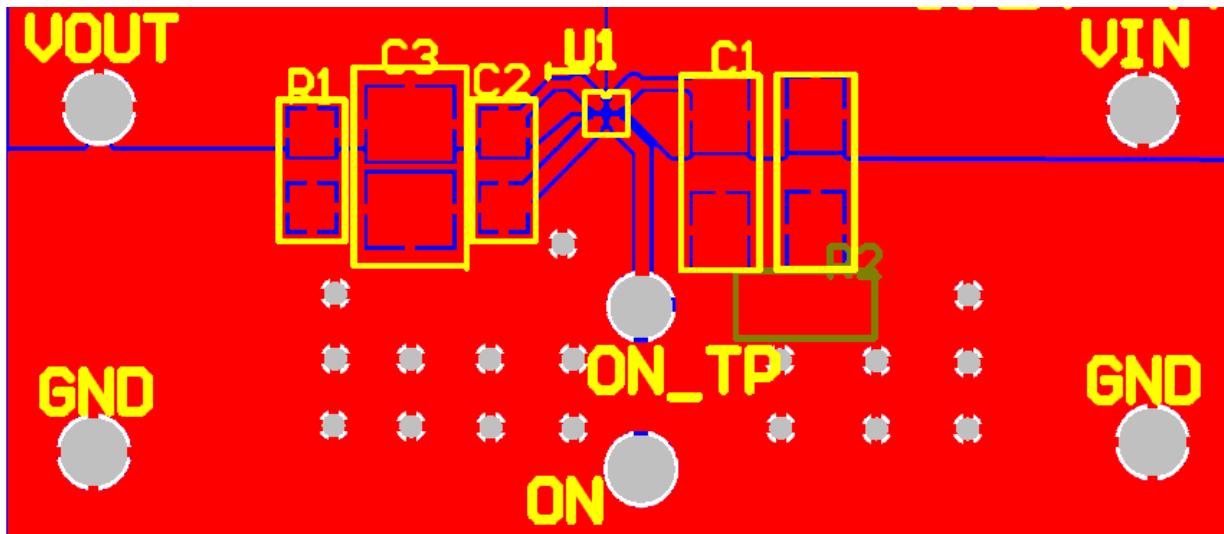


图 17. 建议焊盘模式和布局

以下信息适用到下一个页面上的 WLCSP 封装尺寸：

产品规格尺寸

产品				
FPF1504UCX				
FPF1504BUCX				
FPF1504LUCX				
FPF1504LBUCX	$960 \mu\text{m} \pm 30 \mu\text{m}$	$960 \mu\text{m} \pm 30 \mu\text{m}$	0.230 mm	0.230 mm

MECHANICAL CASE OUTLINE

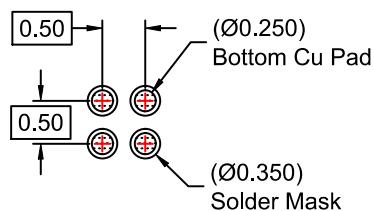
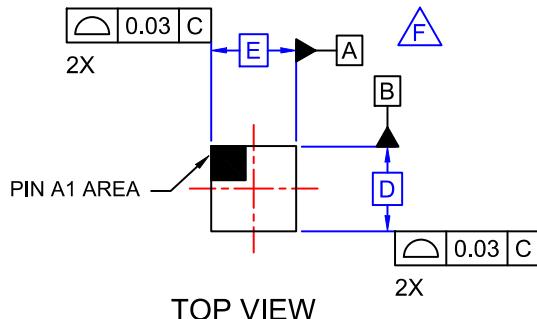
PACKAGE DIMENSIONS

ON Semiconductor®

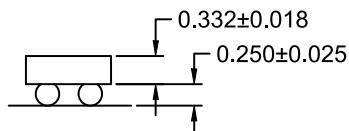
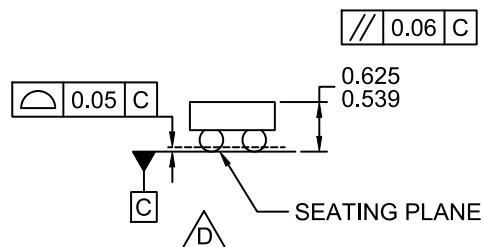


WLCSP4 0.96x0.96x0.582
CASE 567RH
ISSUE O

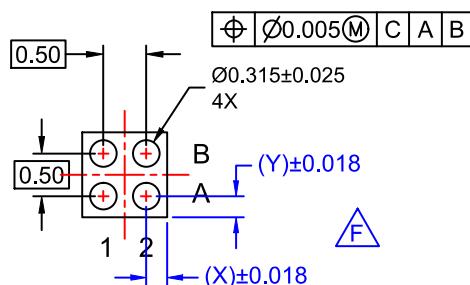
DATE 30 NOV 2016



RECOMMENDED LAND PATTERN
(NSMD PAD TYPE)



SIDE VIEWS



BOTTOM VIEW

NOTES:

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
- E. PACKAGE NOMINAL HEIGHT IS 582 MICRONS ±43 MICRONS (539-625 MICRONS).
- F. FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.

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DESCRIPTION:	WLCSP4 0.96x0.96x0.582	PAGE 1 OF 1

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